CH \$40 00

PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Sang Min Park	02/05/2010
Hyun Lee	02/05/2010
Da Na Jung	02/05/2010

RECEIVING PARTY DATA

Name:	LG Electronics Inc.	
Street Address:	20 Yeouido-dong, Yeongdeungpo-gu	
City:	Seoul	
State/Country:	REPUBLIC OF KOREA	
Postal Code:	150-721	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	29355643

CORRESPONDENCE DATA

Fax Number: (202)739-3001

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: 2027393000

Email: patents@morganlewis.com

Correspondent Name: Robert J. Gaybrick

Address Line 1: 1111 Pennsylvania Avenue NW

Address Line 4: Washington, DISTRICT OF COLUMBIA 20004

ATTORNEY DOCKET NUMBER:	001364-7004
NAME OF SUBMITTER:	Mary Jane Boswell

Total Attachments: 2

source=001364-7004_Assignment-02112010#page1.tif source=001364-7004_Assignment-02112010#page2.tif

PAILNI

REEL: 023926 FRAME: 0372

ATTORNEY DOCKET NO.: 054358-SOLE/JOINT INVENTION (U.S. Rights Only)

ASSIGNMENT

WHEREAS I/We, the below named inventor(s), [hereinafter referred to as Assignor(s)], have made an invention entitled:

CELLULAR PHONE for which I/WE executed an application for United States Letters Patent concurrently herewith; or filed an application for United States Letters Patent on ______, (Application No. _____); and WHEREAS, LG Electronics Inc., a corporation of the Republic of Korea, whose post office address is 20 Yeouido-dong, Yeongdeungpo-gu, Seoul, 150-721, Republic of Korea, (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to issue upon this application; NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from assignee is hereby acknowledged, I/WE, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, MY/OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment; AND, I/WE HEREBY further covenant and agree that I/WE will, without further consideration, communicate with assignee, its successors and assigns, any facts known to ME/US respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns. AND, I/WE HEREBY authorize and request the attorneys I/WE have empowered in the Declaration and Power of Attorney in this application, to insert here in parenthesis (Application No. , filed) the filing date and application number of said application when known. IN TESTIMONY WHEREOF, I/WE have hereunto set our hand(s). Full Name of Sole or First Assignor Assignor's Signature Date February 5, 2010 PARK, SANG MIN Citizenship Address 1076-2, Namhyeon-dong, Gwanak-gu, Seoul, Korea Republic of Korea Full Name of Second Assignor Assignor's Signature Date LEE, HYUN February 5, 2010 Address Citizenship

☐ No

221-506, Mokdong 2 Danji Apt., Mok 6-dong, Yangchcon-gu, Scoul, Korea

Names of additional inventors attached ■Yes

1-WA/1632828.2

Republic of Korea

Full Name of Third Assignor	Assignor's Signature	Date
JUNG, DA NA		February 5, 2010
Address		Citizenship
101-101, Jungmyeong Haniville Apt., 9	965, Dogok 1-dong, Gangnam-gu, Seoul, Korea	Republic of Korea
Full Name of Fourth Assignor	Assignor's Signature	Date
Address		Citizenship
Full Name of Fifth Assignor	Assignor's Signature	Date
Address		Citizenship
Full Name of Sixth Assignor	Assignor's Signature	Date
Address		Citizenship
Full Name of Seventh Assignor	Assignor's Signature	Date
Address		Citizenship
Full Name of Eighth Assignor	Assignor's Signature	Date
Address		Citizenship
Fuli Name of Ninth Assignor	Assignor's Signature	Date
Address		Citizenship
Full Name of Tenth Assignor	Assignor's Signature	Date
Address		Citizenship
Full Name of Eleventh Assignor	Assignor's Signature	Date
Address		Citizenship
Names of additional inventors attached	☐Yes ■No	

1-WA/1632828.2

RECORDED: 02/11/2010